

STGW35NC60W

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40 A, 600 V ultra fast IGBT

Features

- High frequency operation
- Lower C_{RES} / C_{IES} ratio (no cross-conduction susceptibility)

Applications

- High frequency motor controls, inverters, UPS
- HF, SMPS and PFC in both hard switch and resonant topologies

Description

This IGBT utilizes the advanced PowerMESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior.

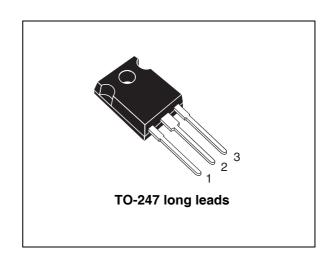


Figure 1. Internal schematic diagram

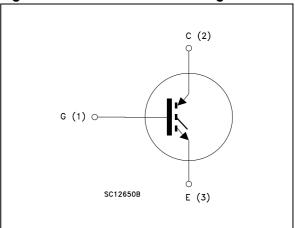


Table 1. Device summary

Order code	Marking	Package	Packaging
STGW35NC60W	GW35NC60W	TO-247 long leads	Tube

November 2008 Rev 1 1/13

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STGW35NC60W Electrical ratings

1 Electrical ratings

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Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	600	V
I _C ⁽¹⁾	Collector current (continuous) at 25 °C	70	Α
I _C ⁽¹⁾	Collector current (continuous) at 100 °C	40	Α
I _{CP} ⁽²⁾	Collector current (pulsed)	150	Α
I _{CL} ⁽³⁾	Turn-off latching current	150	Α
V _{GE}	Gate-emitter voltage	± 20	٧
P _{TOT}	Total dissipation at T _C = 25 °C	260	W
T _{stg}	Storage temperature	_ 55 to 150	္င
T _j	Operating junction temperature	- 55 to 150	

1. Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. Pulse width limited by max junction temperature
- 3. V_{CLAMP} = 80% (V_{CES}), V_{GE} = 15 V, R_{G} = 10 Ω , T_{J} = 150 °C

Table 3. Thermal resistance

Symbol	Parameter Value			
R _{thj-case}	Thermal resistance junction-case IGBT max.	0.48	°C/W	
R _{thj-amb}	Thermal resistance junction-ambient max.	50	°C/W	

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Electrical characteristics STGW35NC60W

2 Electrical characteristics

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(T_{CASE} = 25°C unless otherwise specified)

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	600			V
V _{CE(sat)}	Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 20 A V _{GE} = 15 V, I _C = 20 A,T _C = 125 °C		2.2 1.8	2.6	V V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}, I_{C} = 250 \mu A$	3.75		5.75	٧
I _{CES}	Collector cut-off current (V _{GE} = 0)	V _{CE} = 600 V V _{CE} = 600 V, T _C = 125 °C			250 1	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ±20 V			± 100	nA
9 _{fs}	Forward transconductance	$V_{CE} = 15 V_{,} I_{C} = 20 A$		15		S

Table 5. Dynamic electrical characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{CE} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GE} = 0$		2080 175 52		pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	V_{CE} = 390 V, I_{C} = 20 A, V_{GE} = 15 V, (see Figure 17)		102 17.5 47	140	nC nC nC

Table 6. Switching on/off (inductive load)

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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V, } I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V,}$ (see Figure 16)		29.5 12 1640		ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_{C} = 125 ^{\circ}\text{C} \text{ (see Figure 16)}$		29 13.5 1600		ns ns A/µs
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 390 V, I_{C} = 20 A, R_{GE} = 10 Ω , V_{GE} = 15 V (see Figure 16)		19.5 118 27		ns ns ns
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 390 V, I_{C} = 20 A, R_{GE} = 10 Ω , V_{GE} =15 V, T_{C} = 125 °C (see Figure 16)		46 151 38		ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E _{on} ⁽¹⁾ E _{off} E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 390 \text{ V, } I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V,}$ (see Figure 18)		305 181 486		µJ µJ µJ
E _{on} ⁽¹⁾ E _{off} E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 390 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_{C} = 125^{\circ}\text{C} \text{ (see Figure 18)}$		455 355 810		μJ μJ μJ

Eon is the tun-on losses when a typical diode is used in the test circuit in *Figure 18*. If the IGBT is offered
in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the
same temperature (25°C and 125°C). Eon include diode recovery energy.

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2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

Figure 3. Transfer characteristics

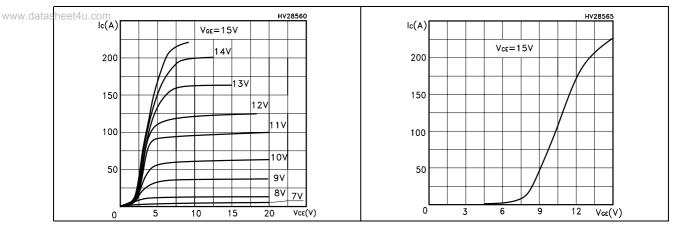


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs temperature

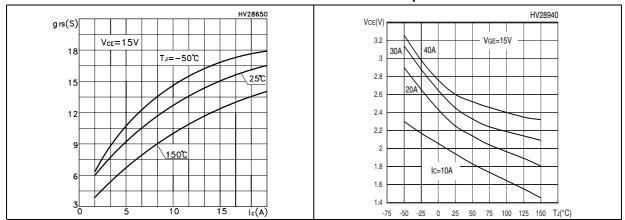


Figure 6. Gate charge vs gate-source voltage Figure 7. Capacitance variations

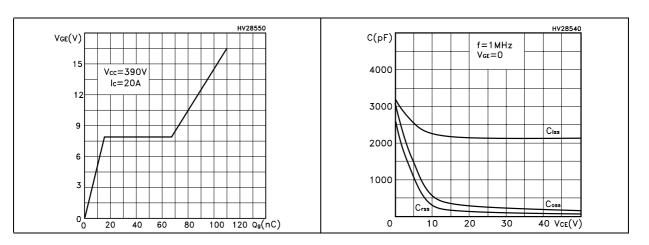


Figure 8. Normalized gate threshold voltage Figure 9. Collector-emitter on voltage vs vs temperature collector current

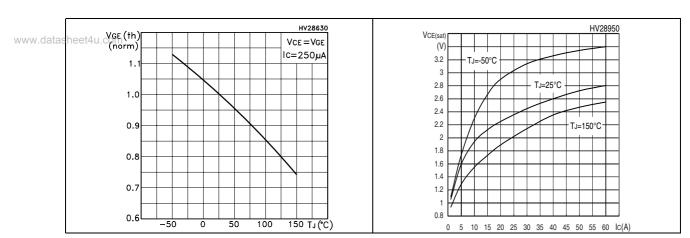


Figure 10. Normalized breakdown voltage vs Figure 11. Switching losses vs temperature temperature

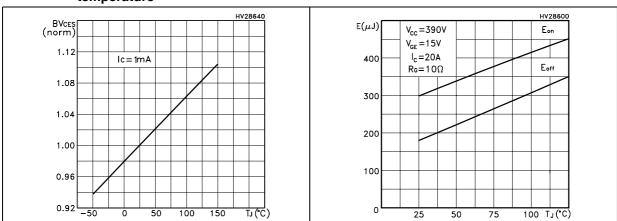
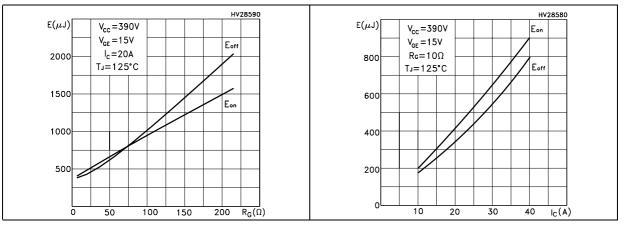


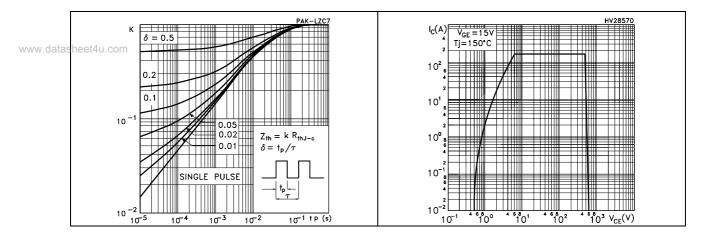
Figure 12. Switching losses vs gate resistance Figure 13. Switching losses vs collector current



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Figure 14. Thermal impedance

Figure 15. Turn-off SOA



STGW35NC60W Test circuit

3 Test circuit

Figure 16. Test circuit for inductive load switching

Figure 17. Gate charge test circuit

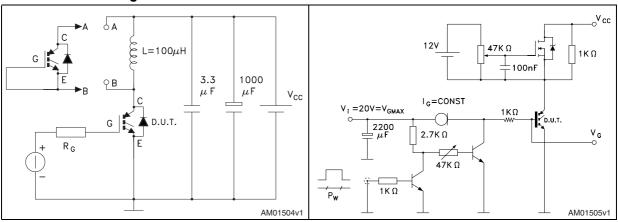
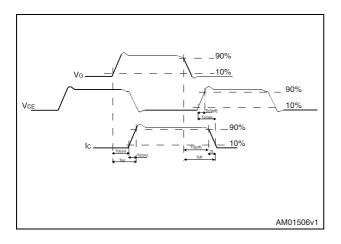


Figure 18. Switching waveform



4 Package mechanical data

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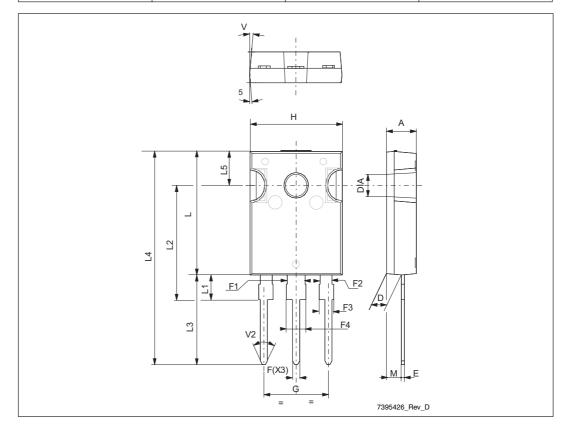
In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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TO-247 long leads mechanical data

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Di		mm	
Dim.	Min.	Тур.	Max.
A	4.85		5.16
D	2.2		2.6
E	0.4		0.8
F	1		1.4
F1		3	
F2		2	
F3	1.9		2.4
F4	3		3.4
G		10.9	
Н	15.45		16.03
L	19.85		21.09
L1	3.7		4.3
L2	18.3		19.13
L3	14.2		20.3
L4	34.05		41.38
L5	5.35		6.3
M	2		3
V		5°	
V2		60°	
DIAM	3.55		3.65



Revision history STGW35NC60W

5 Revision history

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Table 8. Document revision history

Date	Revision	Changes
17-Nov-2008	1	Initial release.

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